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## Trends in HPC and Data Center Power, Packaging, and Cooling <sup>[1]</sup>

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Trends in HPC and Data Center Power, Packaging, and Cooling

[For more information about the event](#) <sup>[2]</sup>

**Presentation file:**

 [CERN\\_Open\\_IT-DC\\_share.pdf](#) <sup>[3]</sup>

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